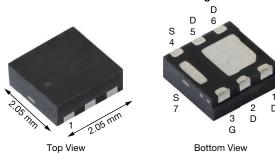
www.vishay.com

Vishay Siliconix

Automotive P-Channel 40 V (D-S) 175 °C MOSFET

PowerPAK® SC-70W-6L Single



Marking Code: QRXXXX

PRODUCT SUMMARY				
V _{DS} (V)	-40			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.0395			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.0545			
I _D (A)	-9			
Configuration	Single			

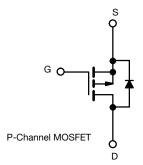
FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % Rq and UIS tested
- · Wettable flank terminals
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912









ORDERING INFORMATION	
Package	PowerPAK SC-70W-6L
Lead (Pb)-free and halogen-free	SQA405CEJW (for detailed order number please see www.vishay.com/doc?79776)

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unlex		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V_{DS}	-40	.,	
Gate-source voltage f		V _{GS} ± 20		- V	
Continuous drain current	T _C = 25 °C ^a		-9		
	T _C = 125 °C	I _D	-7.9		
Continuous source current (diode conduction) a		I _S	-9	А	
Pulsed drain current ^b		I _{DM}	-36		
Single pulse avalanche current		I _{AS}	-13.5		
Single pulse avalanche energy L = 0.1 mH		E _{AS}	9.11	mJ	
Maximum power dissipation	T _C = 25 °C	D	13.6	W	
	T _C = 125 °C	P _D	4.5	VV	
Soldering recommendations (peak temperature) d, e			260		
Operating junction and storage temperature range		T _J , T _{sta}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	LIMIT	UNIT			
Junction-to-ambient	PCB mount c	R _{thJA}	90	°C/W		
Junction-to-case (drain)		R _{thJC}	11	C/VV		

Notes

- a. Package limited
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- c. When mounted on 1" square PCB (FR4 material)
- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-70W-6L is a leadless package and features wettable flank terminals.
 The end of the lead terminal is plated with tin
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- f. Not intended for continuous use with positive gate voltage > 3 V. Operation in the range 3 V < V_{GS} ≤ 12 V is limited to 25 % duty



Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static					•			
Drain-source breakdown voltage	V _{DS}	V _{GS}	= 0, I _D = -250 μA	-40	-	-	V	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$		-2.0	-2.5	V	
Gate-source leakage	I _{GSS}	V _{DS} =	$0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
		$V_{GS} = 0 V$	V _{DS} = -40 V	-	-	-1		
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	$V_{DS} = -40 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$	1	-	-50	μΑ	
		$V_{GS} = 0 V$	$V_{DS} = -40 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$	ı	-	-150		
On-state drain current ^a	I _{D(on)}	$V_{GS} = -10 \text{ V}$	$V_{DS} \ge -5 V$	-8	-	-	Α	
		V _{GS} = -10 V	I _D = -5 A	1	0.0326	0.0395		
Drain source on state resistance a	D	$V_{GS} = -10 \text{ V}$	$I_D = -5 \text{ A}, T_J = 125 ^{\circ}\text{C}$	ı	-	0.0616	Ω	
Drain-source on-state resistance a	R _{DS(on)}	$V_{GS} = -10 \text{ V}$	I _D = -5 A, T _J = 175 °C	1	-	0.0727		
		$V_{GS} = -4.5 \text{ V}$	I _D = -4 A	1	0.0453	0.0545		
Forward transconductance b	9 _{fs}	V _{DS}	= -10 V, I _D = -7 A	ı	18	ı	S	
Dynamic ^b								
Input capacitance	C _{iss}			-	1142	1700		
Output capacitance	Coss	$V_{GS} = 0 V$	V _{DS} = -25 V, f = 1 MHz	-	83	125	рF	
Reverse transfer capacitance	C _{rss}	1			70	105		
Total gate charge ^c	Qg			-	22.6	34		
Gate-source charge ^c	Q _{gs}	V _{GS} = -10 V	$V_{DS} = -20 \text{ V}, I_{D} = -8 \text{ A}$	-	4.4	-	nC	
Gate-drain charge ^c	Q _{gd}	1		-	4.1	-		
Gate resistance	R _g	f = 1 MHz		3.3	6.6	9.9	Ω	
Turn-on delay time ^c	t _{d(on)}			=.	9	15		
Rise time ^c	t _r	V _{DD} :	= -20 V, $R_L = 8 \Omega$	-	4	8	ns	
Turn-off delay time ^c	t _{d(off)}	$I_D \cong -2.5 A$,	V_{GEN} = -10 V, R_g = 1 Ω	-	32	50		
Fall time ^c	t _f			-	6	10		
Source-Drain Diode Ratings and Characteristics	teristics							
Pulsed current ^a	I _{SM}			1	-	-36	Α	
Forward voltage	V_{SD}	I _F	$= -5 \text{ A}, V_{GS} = 0$	-	-0.85	-1.2	V	
Body diode reverse recovery time	t _{rr}			-	14	30	ns	
Body diode reverse recovery charge	Q _{rr}	- I _F = -2 A, di/dt = 100 A/μs		-	9	20	nC	
Reverse recovery fall time	t _a			-	9	-	ns	
Reverse recovery rise time	t _b			-	5	-		
Body diode peak reverse recovery current	I _{RM(REC)}			-	-1.5	-	Α	

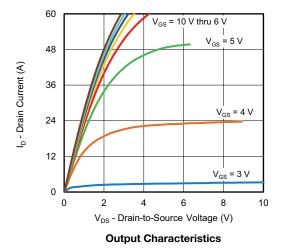
Notes

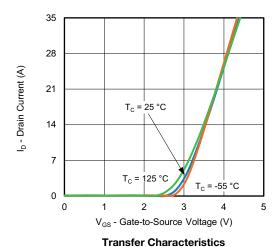
- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

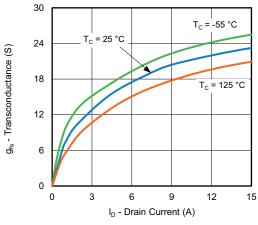
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

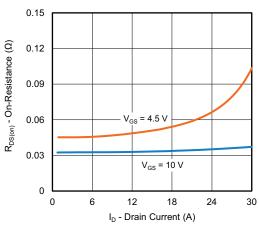


TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



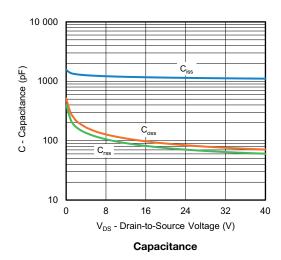


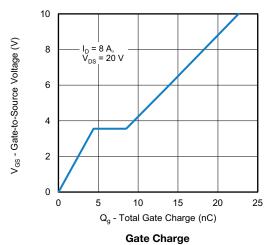






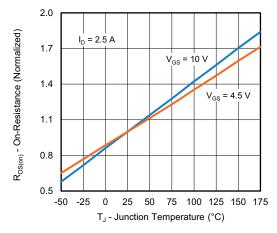
On-Resistance vs. Drain Current



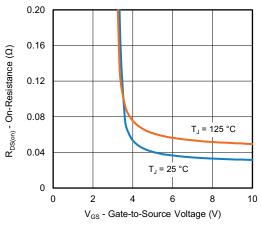




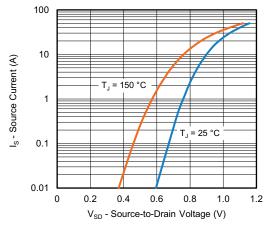
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



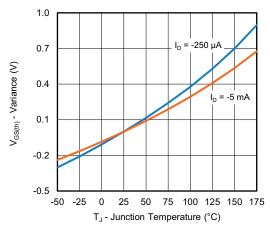
On-Resistance vs. Junction Temperature



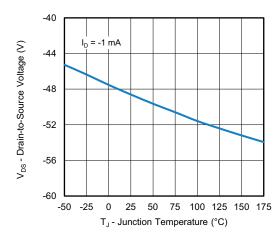
On-Resistance vs. Gate-to-Source Voltage



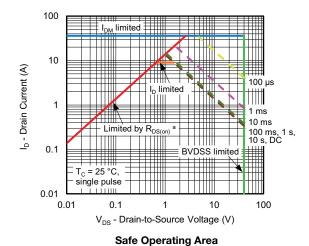
Source-Drain Diode Forward Voltage



Threshold Voltage



Drain Source Breakdown vs. Junction Temperature



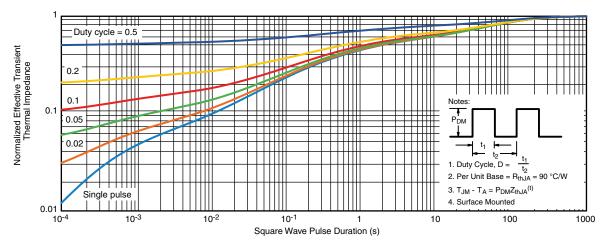
Note

a. $V_{GS} > minimum V_{GS}$ at which $R_{DS(on)}$ is specified

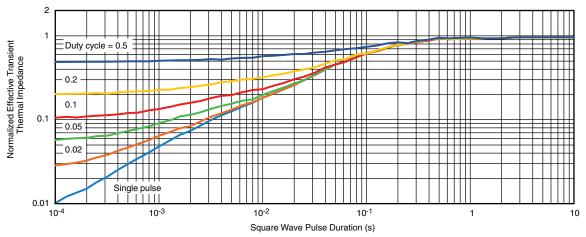
For technical questions, contact: automostechsu



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

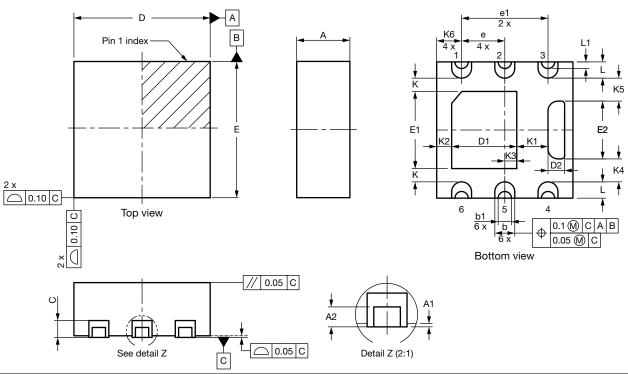


Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63080.



PowerPAK® SC70W-6L SIDEWETTABLE



DIM.		MILLIMETERS		INCHES				
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
Α	0.70	0.80	0.90	0.027	0.031	0.035		
A1	0.00	0.02	0.05	0.000	0.001	0.002		
A2	0.10	-	-	0.004	-	-		
b	0.25	0.30	0.35	0.010	0.012	0.014		
b1	0.15	0.20	0.23	0.006	0.008	0.009		
С	0.20	0.25	0.30	0.008	0.010	0.012		
D	1.95	2.05	2.15	0.077	0.081	0.085		
D1	0.88	0.98	1.08	0.035	0.039	0.043		
D2	0.20	0.25	0.30	0.008	0.010	0.012		
E	1.95	2.05	2.15	0.077	0.081	0.085		
E1	1.06	1.16	1.26	0.042	0.046	0.050		
E2	0.82	0.87	0.92	0.032	0.034	0.036		
е		0.65 BSC			0.026 BSC			
e1		1.30 BSC		0.051 BSC				
K		0.20 typ.		0.008 typ.				
K1		0.47 typ.		0.019 typ.				
K2		0.23 typ.		0.009 typ.				
K3		0.18 typ.			0.007 typ.			
K4		0.35 typ.			0.014 typ.			
K5		0.35 typ.			0.014 typ.			
K6		0.38 typ.			0.015 typ.			
L	0.15	0.25	0.35	0.006	0.010	0.014		
L1	-	0.10	-	-	0.004	-		

DWG: 6076

Notes

- Package outline exclusive of mold flash and metal burr
- Package outline inclusive of plating

Revison: 10-Jan-2020 1 Document Number: 77413



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